

### Power manegement (Dual transistors)

#### <For Tr1>

Parameter	Value
V <sub>CEO</sub>	-12V
Ι <sub>C</sub>	-500mA

#### <For DTr2>

Parameter	Value
V <sub>CC</sub>	50V
I <sub>C(Max.)</sub>	100mA

#### Features

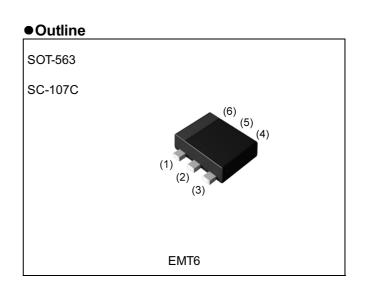
Power switching circuit in a single package.
Mounting cost and area can be cut in half.

# Application

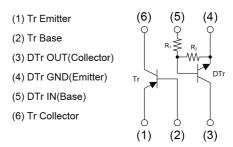
Power manegement

### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMF5	SOT-563 (EMT6)	1616	T2R	180	8	8000	F5



### Inner circuit



## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

### <Tr1>

Parameter	Symbol	Limits	Unit
Collector-base voltage	V <sub>CBO</sub>	-15	V
Collector-emitter voltage	V <sub>CEO</sub>	-12	V
Emitter-base voltage	V <sub>EBO</sub>	-6	V
Collector current	I <sub>C</sub>	-500	mA
Collector current	I <sub>CP</sub> *1	-1	Α

#### <DTr2>

Parameter	Symbol	Limits	Unit
Supply voltage	V <sub>CC</sub>	50	V
Input voltage	V <sub>IN</sub>	-10 to 40	V
Output current	Ι <sub>ο</sub>	30	mA
Collector current	I <sub>C(MAX)</sub>	100	mA

### <Tr1> <DTr2>

Parameter	Symbol	Limits	Unit
Power dissipation	P <sub>D</sub> <sup>*2*4</sup>	150	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to 150	°C



Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV <sub>CBO</sub>	Ι <sub>C</sub> = -10μΑ	-15	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = -1mA	-12	-	-	V
Emitter-base breakdown voltage	$BV_{EBO}$	Ι <sub>Ε</sub> = -10μΑ	-6	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -15V	-	-	-100	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -6V	-	-	-100	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	l <sub>C</sub> = -200mA, l <sub>B</sub> = -10mA	-	-100	-250	mV
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = -2V, I <sub>C</sub> = -10mA	270	-	680	-
Transition frequency	f⊤	V <sub>CE</sub> = -2V, I <sub>E</sub> = 10mA, f = 100MHz	-	260	-	MHz
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = -10V, I <sub>E</sub> = 0A, f = 1MHz	-	6.5	-	pF

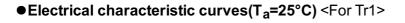
### ●Electrical characteristics (T<sub>a</sub> = 25°C) <For Tr1>

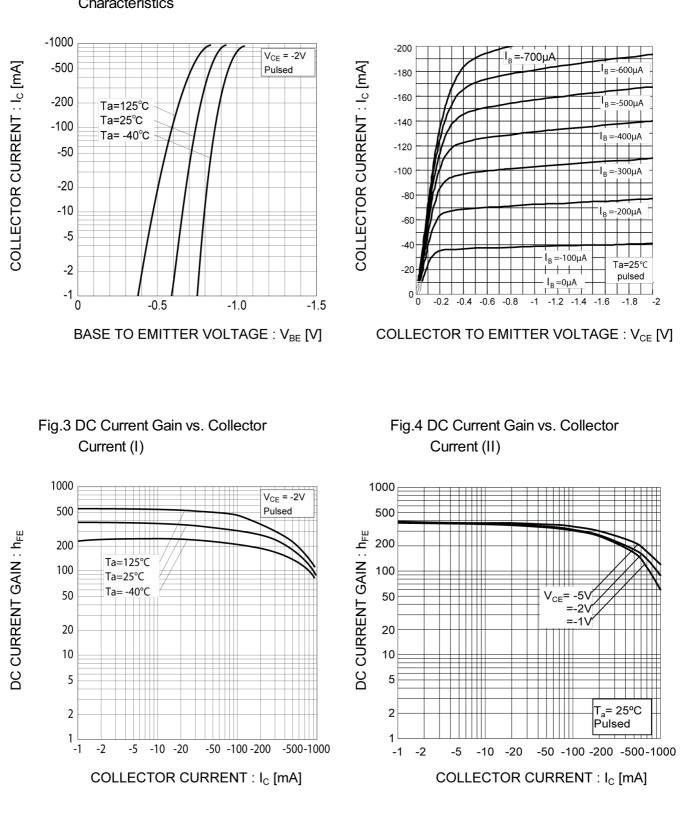
#### •Electrical characteristics (Ta = 25°C) <For DTr2>

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
	V <sub>I(off)</sub>	V <sub>CC</sub> = 5V, I <sub>O</sub> = 100µA	-	-	0.5	V
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = 0.3V, I <sub>O</sub> = 2mA	3.0	-	-	V
Output voltage	V <sub>O(on)</sub>	l <sub>O</sub> / l <sub>l</sub> = 10mA / 0.5mA	-	100	300	mV
Input current	I <sub>I</sub>	V <sub>I</sub> = 5V	-	-	180	μA
Output current	I <sub>O(off)</sub>	V <sub>CC</sub> = 50V, VI = 0V	-	-	500	nA
DC current gain	G <sub>I</sub>	V <sub>O</sub> = 5V, I <sub>O</sub> = 5mA	68	-	-	-
Input resistance	R <sub>1</sub>	-	32.9	47	61.1	kΩ
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	-	0.8	1.0	1.2	-
Transition frequency	f <sub>T</sub> *3	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz		250	-	MHz

- \*1 Pw=1ms Single pulse
- \*2 Each termunal mounted on a reference land.
- \*3 Characteristics of built-in transistor.
- \*4 120mW per element must not be exceeded.







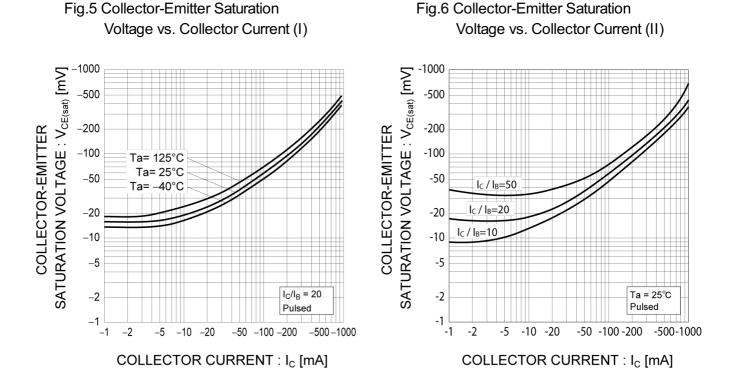
#### Fig.1 Ground Emitter Propagation Characteristics

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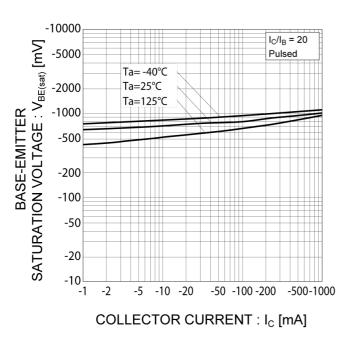


Fig.2 Typical Output Characteristics

### •Electrical characteristic curves(Ta=25°C) <For Tr1>



### Fig.7 Base-Emitter Saturation Voltage vs. Collector Current



### Fig.8 Gain Bandwidth Product vs. Emitter Current

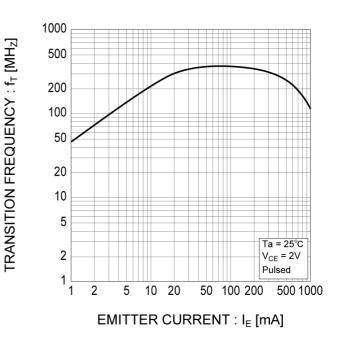
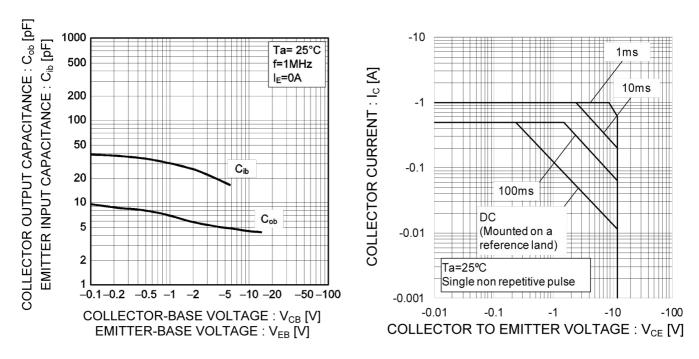




Fig.10 Safe Operating Area

### Electrical characteristic curves(T<sub>a</sub>=25°C) <For Tr1>

Fig.9 Emitter Input Capacitance vs. Emitter-Base Voltage Collector Output Capacitance vs. Collector-Base Voltage





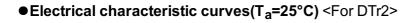
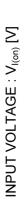


Fig.11 Input voltage vs. output current (ON characteristics)



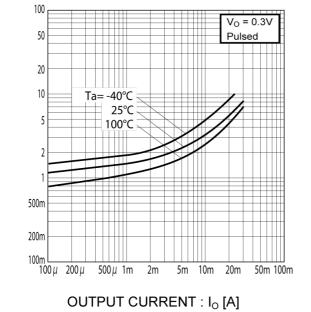


Fig.12 Output current vs. input voltage (OFF characteristics)

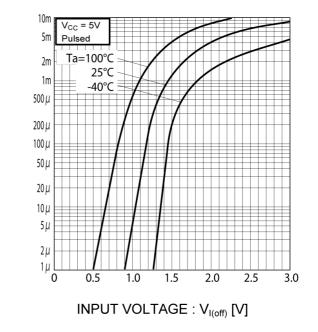


Fig.13 Output current vs. output voltage

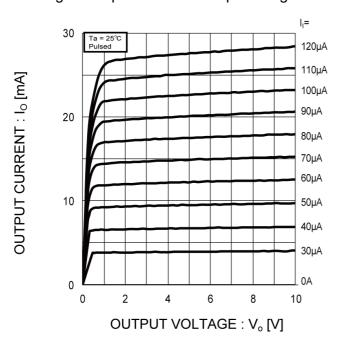
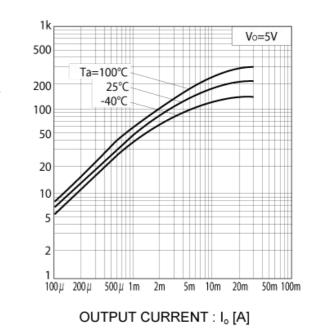


Fig.14 DC current gain vs. output current

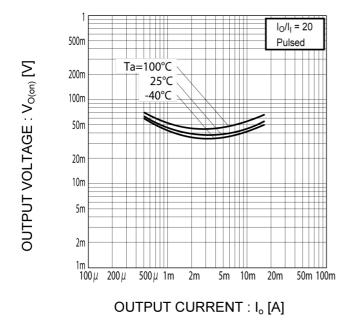




DC CURRENT GAIN : G

OUTPUT CURRENT : I<sub>o</sub> [A]

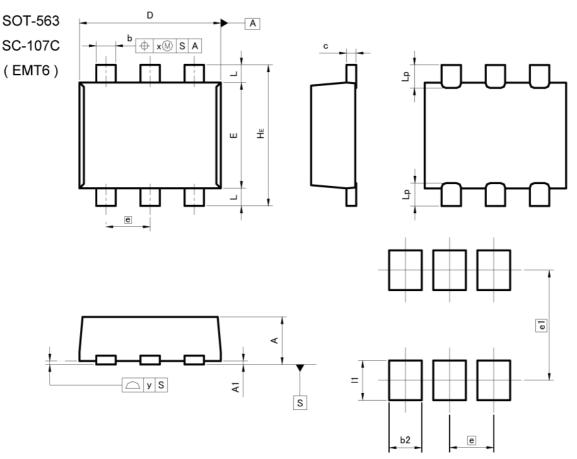
### •Electrical characteristic curves(Ta=25°C) <For DTr2>



### Fig.15 Output voltage vs. output current



### ●外形寸法図



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
с	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
е	0.	50	0.0	20
HE	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	-	0.35	-	0.014
x	-	0.10	-	0.004
У	-	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	-	0.015
e1	1.25		0.049	
- 11	-	0.45	—	0.018

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications
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JÁPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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